Very Low Supply Current 3-Pin Microprocessor Reset Monitors

The MAX809 and MAX810 are cost–effective system supervisor circuits designed to monitor $V_{\rm CC}$ in digital systems and provide a reset signal to the host processor when necessary. No external components are required.

The reset output is driven active within 10 µsec of V_{CC} falling through the reset voltage threshold. Reset is maintained active for a timeout period which is trimmed by the factory after V_{CC} rises above the reset threshold. The MAX810 has an active—high RESET output while the MAX809 has an active—low \overline{RESET} output. Both devices are available in SOT–23 and SC–70 packages.

The MAX809/810 are optimized to reject fast transient glitches on the V_{CC} line. Low supply current of 0.5 μ A (V_{CC} = 3.2 V) makes these devices suitable for battery powered applications.

Features

- Precision V_{CC} Monitor for 1.5 V, 2.5 V, 3.0 V, 3.3 V, and 5.0 V Supplies
- Precision Monitoring Voltages from 1.2 V to 4.9 V Available in 100 mV Steps
- Four Guaranteed Minimum Power–On Reset Pulse Width Available (1 ms, 20 ms, 100 ms, and 140 ms)
- RESET Output Guaranteed to $V_{CC} = 1.0 \text{ V}$.
- Low Supply Current
- Compatible with Hot Plug Applications
- V_{CC} Transient Immunity
- No External Components
- Wide Operating Temperature: -40°C to 105°C
- These Devices are Pb-Free and are RoHS Compliant

Typical Applications

- Computers
- Embedded Systems
- Battery Powered Equipment
- Critical Microprocessor Power Supply Monitoring

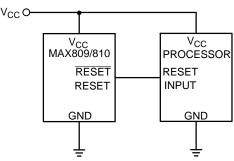
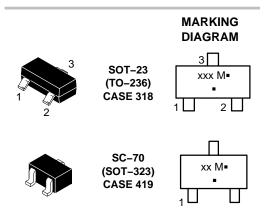


Figure 1. Typical Application Diagram



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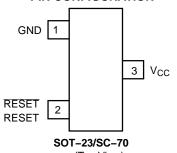


xxx = Specific Device Code M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

PIN CONFIGURATION



(Top View)

NOTE: RESET is for MAX809

ORDERING INFORMATION

RESET is for MAX810

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 10 of this data sheet.

This document contains information on some products that are still under development. ON Semiconductor reserves the right to change or discontinue these products without notice.

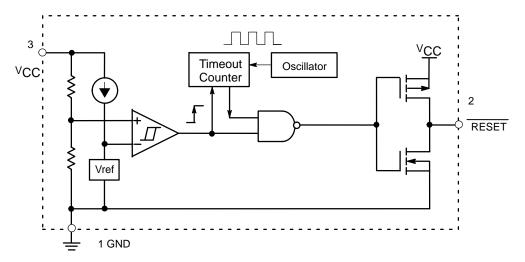


Figure 2. MAX809 Series Complementary Active-Low Output

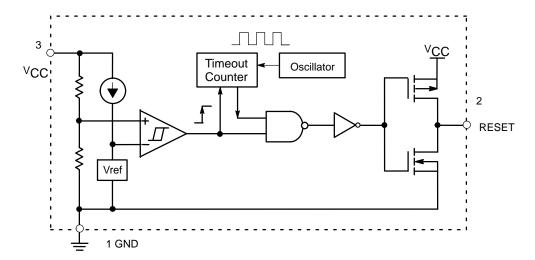


Figure 3. MAX810 Series Complementary Active-High Output

PIN DESCRIPTION

Pin No.	Symbol	Description
1	GND	Ground
2	RESET (MAX809)	RESET output remains low while V_{CC} is below the reset voltage threshold, and for a reset timeout period after V_{CC} rises above reset threshold
2	RESET (MAX810)	RESET output remains high while V_{CC} is below the reset voltage threshold, and for a reset timeout period after V_{CC} rises above reset threshold
3	V _{CC}	Supply Voltage (Typ)

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Power Supply Voltage (V _{CC} to GND)	V _{CC}	-0.3 to 6.0	V
RESET Output Voltage (CMOS)		-0.3 to (V _{CC} + 0.3)	V
Input Current, V _{CC}		20	mA
Output Current, RESET		20	mA
dV/dt (V _{CC})		100	V/μsec
Thermal Resistance, Junction-to-Air (Note 1) SOT-23 SC-70	000	301 314	°C/W
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Lead Temperature (Soldering, 10 Seconds)	T _{sol}	+260	°C
ESD Protection Human Body Model (HBM): Following Specification JESD22-A114 Machine Model (MM): Following Specification JESD22-A115		2000 200	V
Latchup Current Maximum Rating: Following Specification JESD78 Class II Positive Negative		200 200	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. This based on a 35x35x1.6mm FR4 PCB with 10mm² of 1 oz copper traces under natural convention conditions and a single component

2. The maximum package power dissipation limit must not be exceeded.

$$P_D = \frac{IJ(max) - IA}{R_{\theta}JA} \quad \text{with } T_{J(max)} = 150^{\circ}C$$

characterization.

ELECTRICAL CHARACTERISTICS $T_A = -40^{\circ}C$ to $+105^{\circ}C$ unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$. (Note 3)

Characteristic	Symbol	Min	Тур	Max	Unit
V_{CC} Range $T_A = 0^{\circ}C$ to +70°C $T_A = -40^{\circ}C$ to +105°C (Note 4)		1.0 1.2	- -	5.5 5.5	V
Supply Current $V_{CC} = 3.3 \text{ V}$ $T_{A} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $T_{A} = 85^{\circ}\text{C to } +105^{\circ}\text{C (Note 5)}$	lcc	- -	0.5 -	1.2 2.0	μΑ
$V_{CC} = 5.5 \text{ V}$ $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $T_A = 85^{\circ}\text{C to } +105^{\circ}\text{C (Note 5)}$		-	0.8 -	1.8 2.5	
Reset Threshold (V _{in} Decreasing) (Note 6)	V _{TH}				V
MAX809SN490 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		4.83 4.78 4.66	4.9 - -	4.97 5.02 5.14	
MAX8xxLTR, MAX8xxSQ463 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		4.56 4.50 4.40	4.63 - -	4.70 4.75 4.86	
MAX809HTR $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		4.48 4.43 4.32	4.55	4.62 4.67 4.78	
MAX8xxMTR, MAX8xxSQ438 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		4.31 4.27 4.16	4.38	4.45 4.49 4.60	
MAX809JTR, MAX8xxSQ400 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		3.94 3.90 3.80	4.00 - -	4.06 4.10 4.20	
MAX8xxTTR, MAX809SQ308 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		3.04 3.00 2.92	3.08 - -	3.11 3.16 3.24	
MAX8xxSTR, MAX8xxSQ293 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		2.89 2.85 2.78	2.93 - -	2.96 3.00 3.08	
MAX8xxRTR, MAX8xxSQ263 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		2.59 2.56 2.49	2.63 - -	2.66 2.70 2.77	
MAX809SN232, MAX809SQ232 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		2.28 2.25 2.21	2.32 - -	2.35 2.38 2.45	
MAX809SN160 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		1.58 1.56 1.52	1.60 - -	1.62 1.64 1.68	
MAX809SN120, MAX8xxSQ120 $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C $T_A = +85^{\circ}C$ to +105°C (Note 5)		1.18 1.17 1.14	1.20 - -	1.22 1.23 1.26	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 3. Production testing done at $T_A = 25^{\circ}\text{C}$, over temperature limits guaranteed by design. 4. For NCV automotive devices, this temperature range is $T_A = -40^{\circ}\text{C}$ to +125°C. 5. For NCV automotive devices, this temperature range is $T_A = +85^{\circ}\text{C}$ to +125°C.

- 6. Contact your ON Semiconductor sales representative for other threshold voltage options.

ELECTRICAL CHARACTERISTICS (continued) $T_A = -40^{\circ}C$ to +105°C unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$. (Note 7)

Characteristic	Symbol	Min	Тур	Max	Unit
Detector Voltage Threshold Temperature Coefficient		-	30	_	ppm/°C
V _{CC} to Reset Delay V _{CC} = V _{TH} to (V _{TH} - 100 mV)		-	10	_	μsec
Reset Active TimeOut Period (Note 8) MAX8xxSN(Q)293D1 MAX8xxSN(Q)293D2 MAX8xxSN(Q)293D3 MAX8xxSN(Q)293	t _{RP}	1.0 20 100 140	- - - -	3.3 66 330 460	msec
$\begin{array}{l} \textbf{RESET Output Voltage Low (No Load) (MAX809)} \\ \textbf{V}_{CC} = \textbf{V}_{TH} - 0.2 \ \textbf{V} \\ \textbf{1.6 V} \leq \textbf{V}_{TH} \leq 2.0 \ \textbf{V}, \ \textbf{I}_{SINK} = 0.5 \ \textbf{mA} \\ \textbf{2.1 V} \leq \textbf{V}_{TH} \leq 4.0 \ \textbf{V}, \ \textbf{I}_{SINK} = 1.2 \ \textbf{mA} \\ \textbf{4.1 V} \leq \textbf{V}_{TH} \leq 4.9 \ \textbf{V}, \ \textbf{I}_{SINK} = 3.2 \ \textbf{mA} \end{array}$	V _{OL}	-	-	0.3	V
RESET Output Voltage High (No Load) (MAX809) $V_{CC} = V_{TH} + 0.2 \text{ V}$ 1.6 V ≤ V_{TH} ≤ 2.4 V, $I_{SOURCE} = 200 \text{ μA}$ 2.5 V ≤ V_{TH} ≤ 4.9 V, $I_{SOURCE} = 500 \text{ μA}$	V _{OH}	0.8 V _{CC}	-	-	V
RESET Output Voltage High (No Load) (MAX810) $V_{CC} = V_{TH} - 0.2 \text{ V}$ $1.6 \text{ V} \leq V_{TH} \leq 2.4 \text{ V, } I_{SOURCE} = 200 \mu\text{A}$ $2.5 \text{ V} \leq V_{TH} \leq 4.9 \text{ V, } I_{SOURCE} = 500 \mu\text{A}$	V _{OH}	0.8 V _{CC}	-	-	V
$\begin{aligned} & \text{RESET Output Voltage Low (No Load) (MAX810)} \\ & \text{V}_{\text{CC}} = \text{V}_{\text{TH}} + 0.2 \text{ V} \\ & 1.6 \text{ V} \leq \text{V}_{\text{TH}} \leq 2.0 \text{ V}, \text{I}_{\text{SINK}} = 0.5 \text{ mA} \\ & 2.1 \text{ V} \leq \text{V}_{\text{TH}} \leq 4.0 \text{ V}, \text{I}_{\text{SINK}} = 1.2 \text{ mA} \\ & 4.1 \text{ V} \leq \text{V}_{\text{TH}} \leq 4.9 \text{ V}, \text{I}_{\text{SINK}} = 3.2 \text{ mA} \end{aligned}$	V _{OL}	-	-	0.3	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

7. Production testing done at T_A = 25°C, over temperature limits guaranteed by design.

8. Contact your ON Semiconductor sales representative for timeout options availability for other threshold voltage options.

TYPICAL OPERATING CHARACTERISTICS

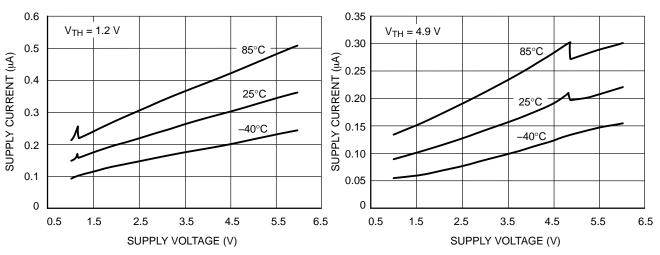


Figure 4. Supply Current vs. Supply Voltage

Figure 5. Supply Current vs. Supply Voltage

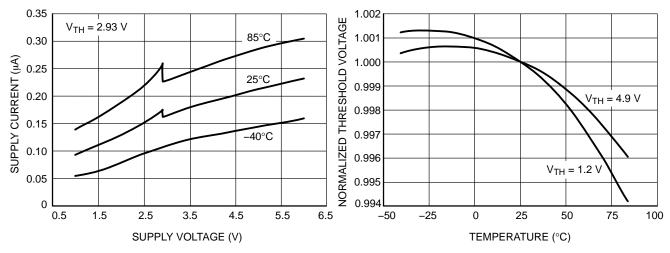


Figure 6. Supply Current vs. Supply Voltage

Figure 7. Normalized Reset Threshold Voltage vs. Temperature

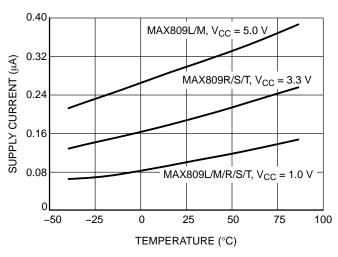


Figure 8. Supply Current vs. Temperature (No Load, MAX809)

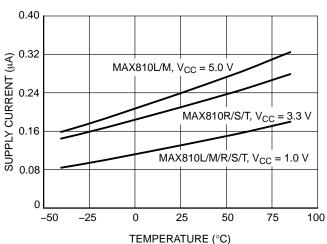


Figure 9. Supply Current vs. Temperature (No Load, MAX810)

TYPICAL OPERATING CHARACTERISTICS

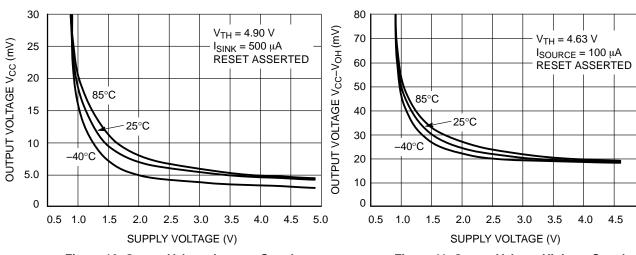


Figure 10. Output Voltage Low vs. Supply Voltage

Figure 11. Output Voltage High vs. Supply Voltage

5.0

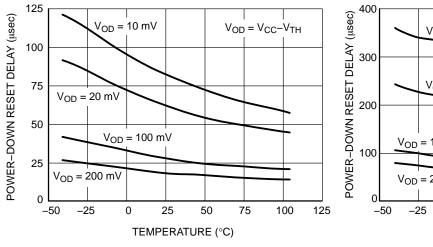


Figure 12. Power–Down Reset Delay vs. Temperature and Overdrive ($V_{TH} = 1.2 \text{ V}$)

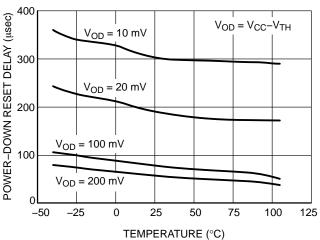


Figure 13. Power–Down Reset Delay vs. Temperature and Overdrive (V_{TH} = 4.9 V)

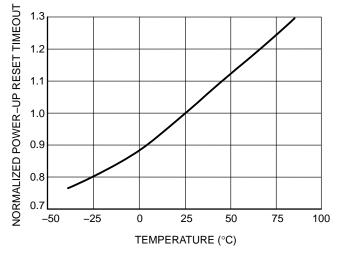


Figure 14. Normalized Power-Up Reset vs. Temperature

Detail Operation Description

The MAX809/810 series microprocessor reset supervisory circuits are designed to monitor the power supplies in digital systems and provide a reset signal to the processor without any external components. Figure 2 shows the timing diagram and a typical application below. Initially consider that input voltage $V_{\rm CC}$ is at a nominal level greater than the voltage detector upper threshold ($V_{\rm TH}$). And the

RESET (RESET) output voltage (Pin 2) will be in the high state for MAX809, or in the low state for MAX 810 devices.

If there is an input power interruption and V_{CC} becomes significantly deficient, it will fall below the lower detector threshold (V_{TH}). This event causes the RESET output to be in the low state for the MAX809, or in the high state for the NCP810 devices. After completion of the power interruption, V_{CC} will rise to its nominal level and become greater than the V_{TH} . This sequence activates the internal oscillator circuitry and digital counter to count. After the count of the timeout period, the reset output will revert back to the original state.

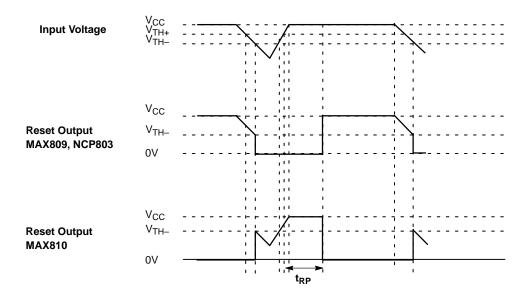
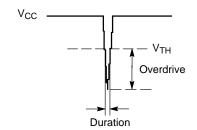


Figure 15. Timing Waveforms

APPLICATIONS INFORMATION

V_{CC} Transient Rejection

The MAX809 provides accurate V_{CC} monitoring and reset timing during power-up, power-down, and brownout/sag conditions, and rejects negative-going transients (glitches) on the power supply line. Figure 16 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive which lies **under** the curve will **not** generate a reset signal. Combinations above the curve are detected as a brownout or power-down. Typically, transient that goes 100 mV below the reset threshold and lasts 5.0 μ s or less will not cause a reset pulse. Transient immunity can be improved by adding a capacitor in close proximity to the V_{CC} pin of the MAX809.



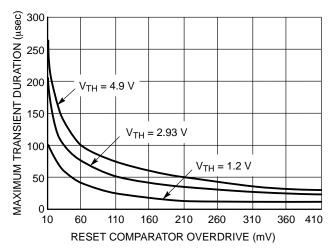


Figure 16. Maximum Transient Duration vs. Overdrive for Glitch Rejection at 25°C

RESET Signal Integrity During Power–Down

The MAX809 $\overline{\text{RESET}}$ output is valid to $V_{CC}=1.0~\text{V}$. Below this voltage the output becomes an "open circuit" and does not sink current. This means CMOS logic inputs to the Microprocessor will be floating at an undetermined voltage. Most digital systems are completely shutdown well above this voltage. However, in situations where $\overline{\text{RESET}}$ must be

maintained valid to $V_{CC} = 0$ V, a pull-down resistor must be connected from \overline{RESET} to ground to discharge stray capacitances and hold the output low (Figure 17). This resistor value, though not critical, should be chosen such that it does not appreciably load \overline{RESET} under normal operation (100 k Ω will be suitable for most applications).

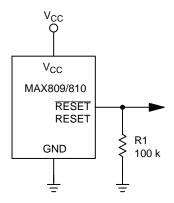


Figure 17. Ensuring RESET Valid to $V_{CC} = 0 \text{ V}$

Processors With Bidirectional I/O Pins

Some Microprocessor's have bidirectional reset pins. Depending on the current drive capability of the processor pin, an indeterminate logic level may result if there is a logic conflict. This can be avoided by adding a 4.7 k Ω resistor in series with the output of the MAX809 (Figure 18). If there are other components in the system which require a reset signal, they should be buffered so as not to load the reset line. If the other components are required to follow the reset I/O of the Microprocessor, the buffer should be connected as shown with the solid line.

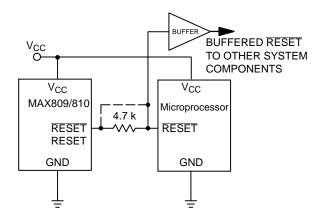


Figure 18. Interfacing to Bidirectional Reset I/O

ORDERING, MARKING AND THRESHOLD INFORMATION

Part Number	V _{TH} * (V)	Timeout* (ms)	Description	Marking	Package	Shipping [†]
MAX809SN160T1G	1.60	140–460		SAA		
MAX809SN232T1G	2.32	140–460		SQP]	
MAX809RTRG	2.63	140–460		SPS]	
NCV809RTRG	2.63	140–460		RPA		
MAX809STRG	2.93	140–460		SPT]	
NCV809STRG	2.93	140–460	1	SUC		
MAX809TTRG	3.08	140–460		SPU		
MAX809JTRG	4.00	140–460		SPR		
MAX809MTRG	4.38	140–460		SPV		
NCV809MTRG	4.38	140–460		TAT	SOT23-3	0000 /T 0 D 1
MAX809HTRG	4.55	140–460		SBD	(Pb-Free)	3000 / Tape & Reel
MAX809LTRG	4.63	140–460		SPW		
NCV809LTRG	4.63	140–460		STA		
MAX809SN490T1G	4.90	140–460		SBH		
MAX809SN120T1G	1.20	140–460		SSO		
MAX809SN293D1T1G	2.93	1–3.3		SSP		
NCV809SN293D1T1G*			Push-Pull RESET	ACT		
MAX809SN293D2T1G	2.93	20–66		SSQ		
NCV809SN293D2T1G	2.93	20–66	1	ACE		
MAX809SN293D3T1G	2.93	100–330		SSR		
MAX809SQ120T1G	1.20	140–460		ZD		
MAX809SQ232T1G	2.32	140–460		ZE		
MAX809SQ263T1G	2.63	140–460		ZF		
MAX809SQ293T1G	2.93	140–460		ZG		
NCV809SQ293T1G* (In Development)						
MAX809SQ308T1G	3.08	140–460		ZH	SC70-3	3000 / Tape & Reel
MAX809SQ400T1G	4.00	140–460		SZ	(Pb-Free)	·
MAX809SQ438T1G	4.38	140–460		ZI		
MAX809SQ463T1G	4.63	140–460		ZJ	1	
MAX809SQ293D1T1G	2.93	1–3.3		ZK	1	
MAX809SQ293D2T1G	2.93	20–66		ZL	1	
MAX809SQ293D3T1G	2.93	100–330	1	ZM	1	

ORDERING, MARKING AND THRESHOLD INFORMATION

Part Number	V _{TH} ** (V)	Timeout** (ms)	Description	Marking	Package	Shipping [†]
MAX810RTRG	2.63	140–460		SPX		
MAX810STRG	2.93	140–460	1	SPY		
MAX810TTRG	3.08	140–460		SPZ		
MAX810MTRG	4.38	140–460		SQA		
MAX810LTRG	4.63	140–460		SQB	SOT23-3 (Pb-Free)	3000 / Tape & Reel
MAX810SN120T1G	1.20	140–460	1	SSS	(1.2.1.00)	
MAX810SN293D1T1G	2.93	1–3.3	1	SST		
MAX810SN293D2T1G	2.93	20–66	1	SSU		
MAX810SN293D3T1G	2.93	100–330	1	SSZ		
MAX810SQ120T1G	1.20	140–460	Push-Pull RESET	ZN		
MAX810SQ263T1G	2.63	140–460	1	ZO		
MAX810SQ270T1G	2.70	20–66	1	ZB		
MAX810SQ293T1G	2.93	140–460	1	ZP		
MAX810SQ400T1G	4.00	20–66		ZC	SC70-3	
MAX810SQ438T1G	4.38	140–460	ZF ZS	ZQ	(Pb-Free)	3000 / Tape & Reel
MAX810SQ463T1G	4.63	140–460		ZR		
MAX810SQ293D1T1G	2.93	1–3.3		ZS	1	
MAX810SQ293D2T1G	2.93	20–66		ZT	1	
MAX810SQ293D3T1G	2.93	100–330	1	ZU	1	

[†]For information on tape and reel specifications,including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.
**Contact your ON Semiconductor sales representative for other threshold voltage options.

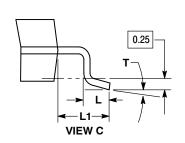


SOT-23 (TO-236) CASE 318-08 **ISSUE AS**

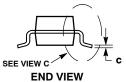
DATE 30 JAN 2018

SCALE 4:1 D - 3X b

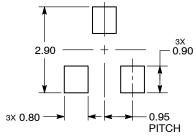
TOP VIEW







RECOMMENDED SOLDERING FOOTPRINT



DIMENSIONS: MILLIMETERS

3. ANODE

NOTES:

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
 MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS				INCHES	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
Т	O٥		100	O٥		10°

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE	ı	
STYLE 9:	STYLE 10:	STYLE 11:	STYLE 12:	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. SOURCE	PIN 1. CATHODE
2. ANODE	2. SOURCE	2. CATHODE	2. CATHODE	2. DRAIN	2. GATE
3. CATHODE	3. GATE	3. CATHODE-ANODE	3. ANODE	3. GATE	3. ANODE
STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:	STYLE 19:	STYLE 20:
PIN 1. GATE	PIN 1. ANODE	PIN 1. NO CONNECTION	PIN 1. NO CONNECTION	PIN 1. CATHODE	PIN 1. CATHODE
2. CATHODE	2. CATHODE	2. ANODE	2. CATHODE	2. ANODE	2. ANODE
3. ANODE	3. CATHODE	3. CATHODE	3. ANODE	3. CATHODE-ANODE	3. GATE
STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:	STYLE 25:	STYLE 26:
PIN 1. GATE	PIN 1. RETURN	PIN 1. ANODE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE
2. SOURCE	2. OUTPUT	2. ANODE	2. DRAIN	2. CATHODE	2. ANODE
3. DRAIN	3. INPUT	3. CATHODE	3. SOURCE	3. GATE	3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE				

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DESCRIPTION:	SOT-23 (TO-236)		PAGE 1 OF 1		

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3. CATHODE





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END VIEW

DATE 07 OCT 2021

NOTES:

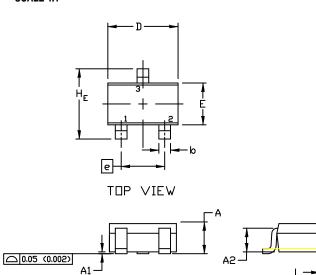
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH

	MILLIMETERS				INCHES	
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
Α	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2		0.70 REF			0.028 BS	С
b	0.30	0.35	0.40	0.012	0.014	0.016
С	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
e	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC				0.026 BS	C
L	0.20	0.38	0.56	0.008	0.015	0.022
HE	2.00	2.10	2.40	0.079	0.083	0.095
e e1 L	1.20	1.30 0.65 BSC 0.38	1.40	0.047	0.051 0.026 BS 0.015	0.05 C 0.02



For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

SOLDERING FOOTPRINT



GENERIC MARKING DIAGRAM

SIDE VIEW



XX = Specific Device Code

M = Date Code

■ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1: CANCELLED	STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE	STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE	
STYLE 6:	STYLE 7:	STYLE 8:	STYLE 9:	STYLE 10:	STYLE 11:
PIN 1. EMITTER	PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. CATHODE
2. BASE	2. EMITTER	2. SOURCE	2. CATHODE	2. ANODE	2. CATHODE
3. COLLECTOR	3. COLLECTOR	3. DRAIN	3. CATHODE-ANODE	3. ANODE-CATHODE	3. CATHODE

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DESCRIPTION:	SC-70 (SOT-323)		PAGE 1 OF 1		

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